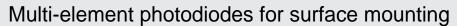
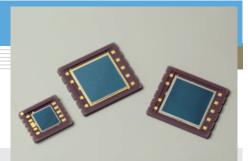
Si PIN photodiode

S5980, S5981, S5870





Features

 Large active area S5980: 5 x 5 mm

S5981: 10 × 10 mm S5870: 10 x 10 mm

- Chip carrier package suitable for surface mounting Facilitates automated surface mounting by solder reflow
- Thin package: 1.26 mmt
- Photo sensitivity: 0.72 A/W (λ=960 nm)

■ General ratings					
Parameter	Symbol	S5980	S5981	S5870	Unit
Window material	-	Resin coating			-
Gap between elements	-	30			μm

Applications

Level meters

Laser beam axis alignment

Pointing devices, etc.

Active area

